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FTu4A.5 Silicon-based Nano-phonic Structures



Polygonal silica toroidal microcavity for easy and stable coupling with waveguides

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総務省

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Outline

1. Background
 - ✓ Silica toroidal microcavity
 - ✓ Barriers for practical application
2. Fabrication process for polygonal silica toroid
 - ✓ Anisotropic etching for silicon
3. Mode analysis using 2D-FDTD simulation
 - ✓ WG-like modes of a polygonal cavity
4. Experimental result
5. Summary



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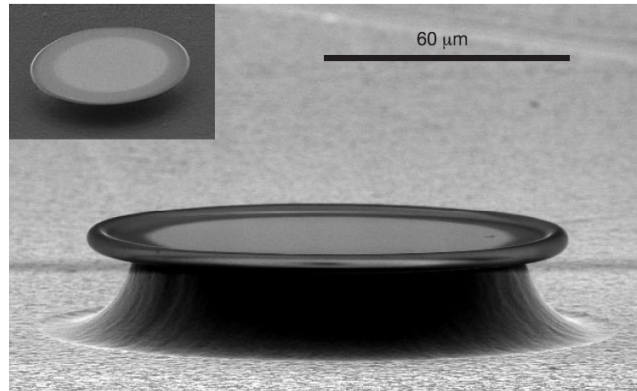
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Silica toroid microcavity



D. K. Armani *et al.*,
Nature **421**, 925 (2003).

Application

- ✓ Optical frequency comb source
- ✓ Single molecule detection
- ✓ Third nonlinear effect

High Q and small V is required

Advantage

- ✓ Ultra high-Q $Q \approx 1.0 \times 10^8$
- ✓ Small mode volume V
- ✓ Silica and fiber couple well
- ✓ Silicon wafer is low cost

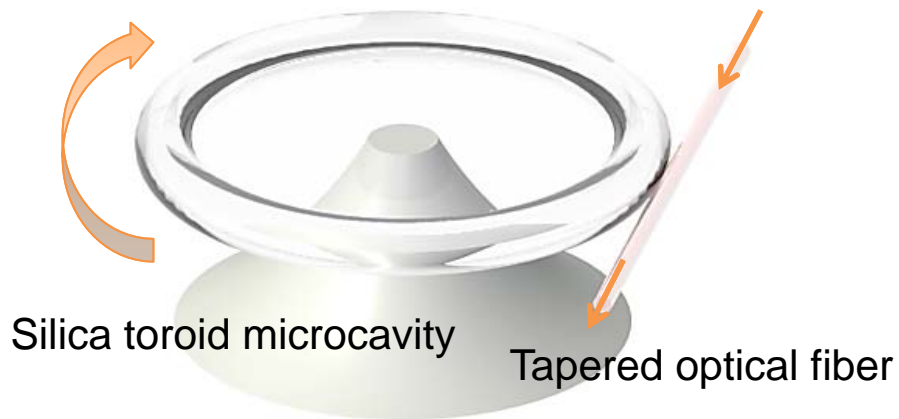
Disadvantage

- ✓ Must use tapered fiber

Vulnerable to vibrations



Coupling light to WGM cavity

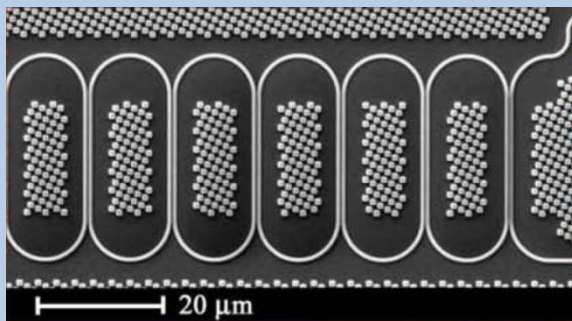


Main coupling difficulties

- ✓ Sensitive control of air gap
- ✓ Fragile tapered fiber

Obstacles for **practical applications**

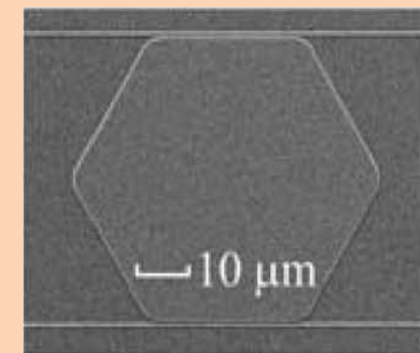
Microcavity design for robust coupling : Non-circular structure



M. L. Cooper *et al.*,
Opt. Lett. **35**, 3030 (2010).

Racetrack type
✓ Long coupling length

Polygon type
✓ Multiple flat sidewalls
for coupling



C. Li *et al.*, IEEE J. Sel. Top.
Quantum Electron. **12**, (2006).



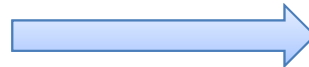
Motivation

Need for an ultrahigh-Q cavity that is robust as regards mechanical vibrations for practical applications

In silicon microrings

Structure must be tolerant to fabrication error

demonstrated



Change cavity design

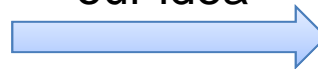
- Racetrack
- Hexagon

Not difficult because we can use CMOS process

Silica toroid microcavities

Coupling w/ tapered fiber must be robust & optimized even in contact

our idea



Fabricate polygonal silica toroid microcavity

But how?

Developing a fabrication method for changing the shape of silica toroid microcavity

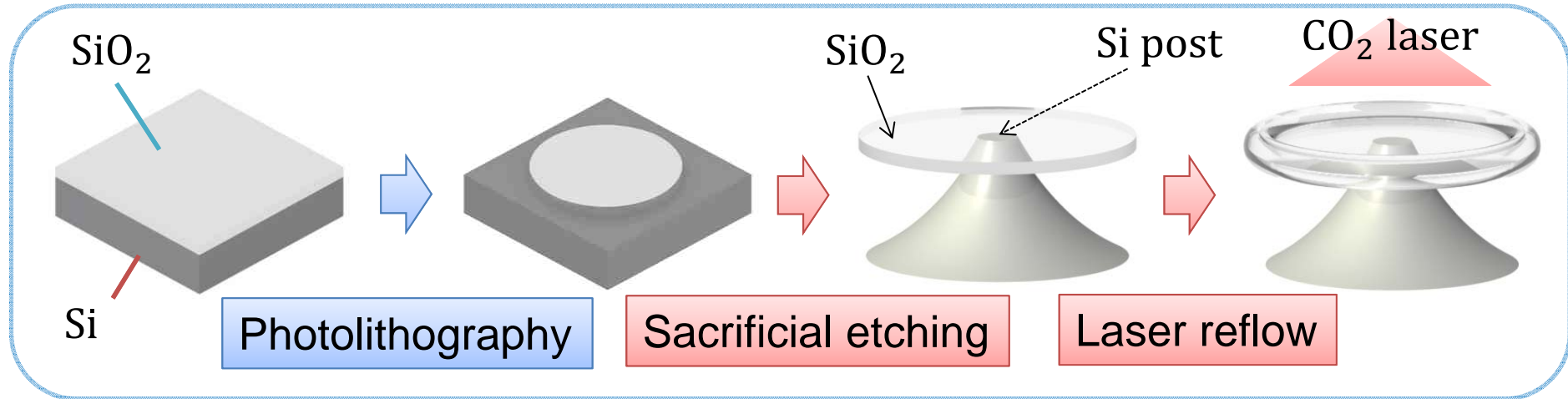


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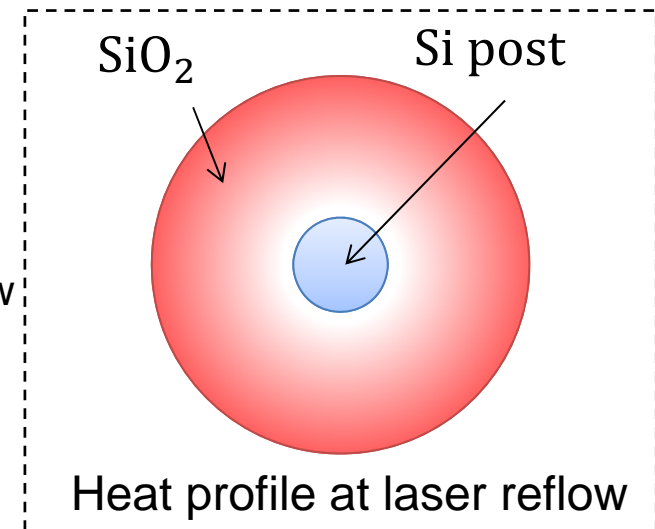


Silica toroid fabrication process



Point

The shape of the SiO₂ toroid depends on the shape of the Si post because the post works as heatsink during the laser reflow

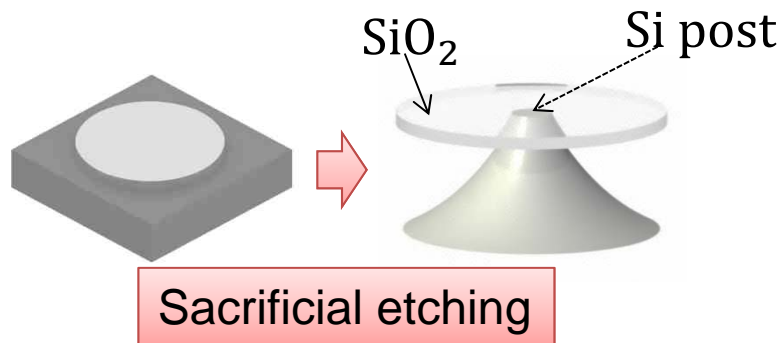


Thermal conductivity(300 K) [W · m⁻¹ · K⁻¹]

{	Si	: 150
	SiO ₂	: 1.74



Fabricating **polygonal** silica toroid



Conventional method

- ✓ XeF₂ gas dry etching : isotropic etchant

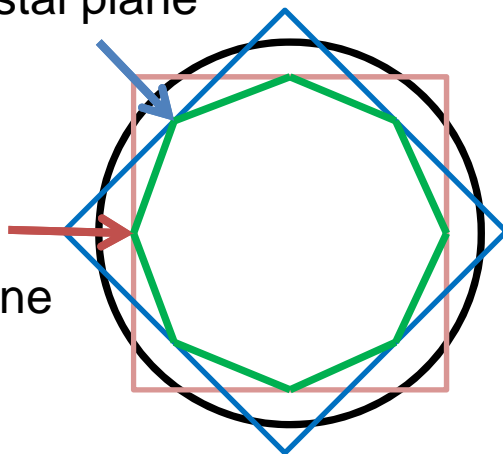
Proposed method

- ✓ KOH wet etching : **anisotropic** etchant

Anisotropic etching for silicon

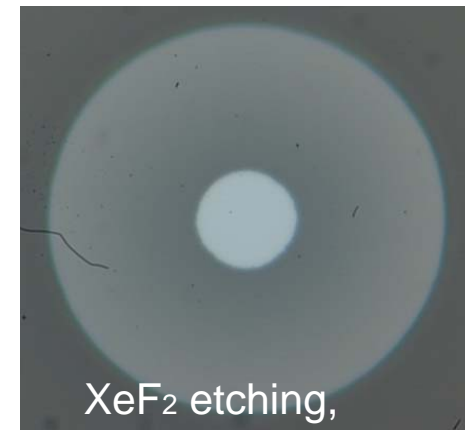
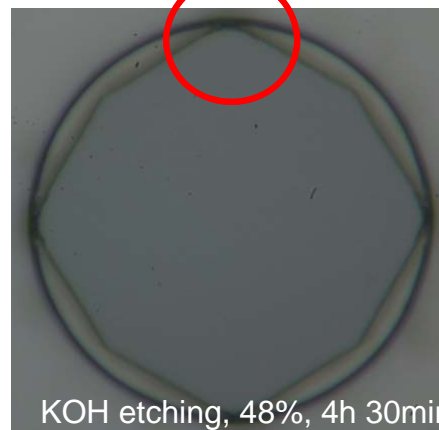
<100> crystal plane

<110> crystal plane



Problem: Undercut is too small

Using only KOH is not enough...

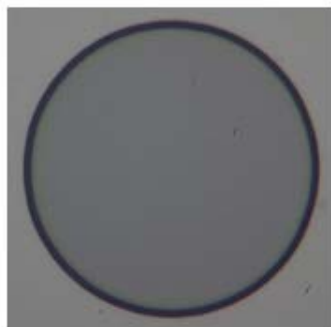




Fabricating **polygonal** silica toroid

To obtain sufficient undercut to fabricate a polygonal silica toroid, we used a combination of **isotropic** and **anisotropic** etching for sacrificial etching

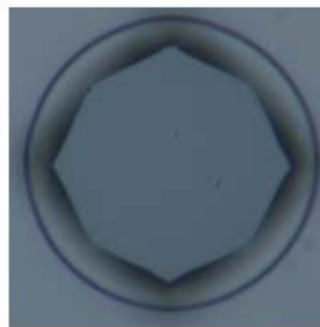
- Fabrication flow
 1. Prepare a substrate after photolithography
 2. Use HNA wet etching (isotropic) for 30 seconds
 - HF(48%): Nitric(69%): Acetic(99%) acids = 3 :5 :3
 3. Use KOH wet etching (anisotropic) for 3 hours
 - KOH(48%), Thermal control
 4. Use CO₂ laser for reflow process
 - 14 W, 100 ms, focal length 38.1 mm



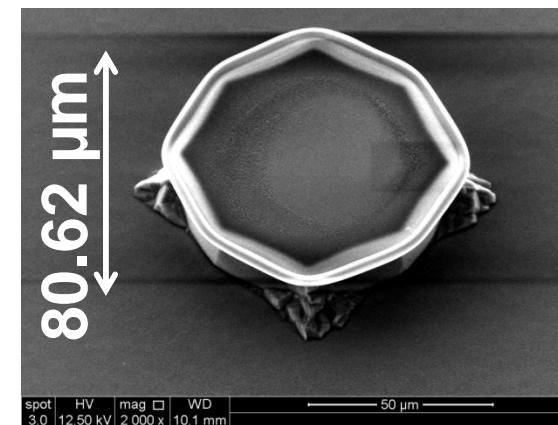
SiO₂ patterning after photolithography



3:5:3 **HNA** etching 30 seconds



KOH 48% etching 3 hours



SEM image of silica toroid after laser reflow



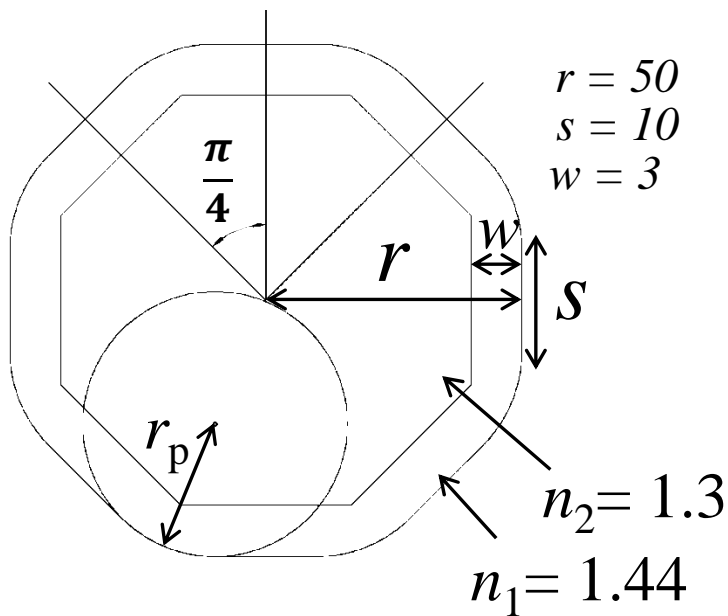
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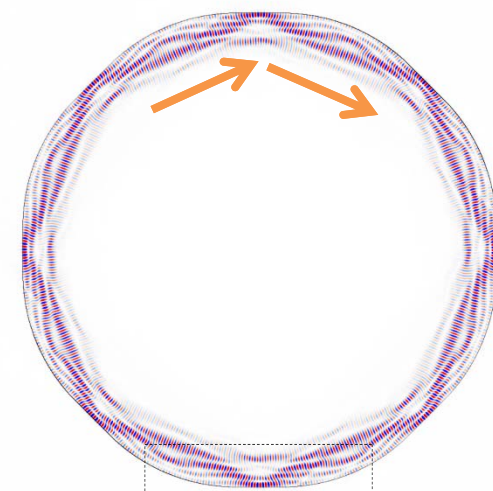
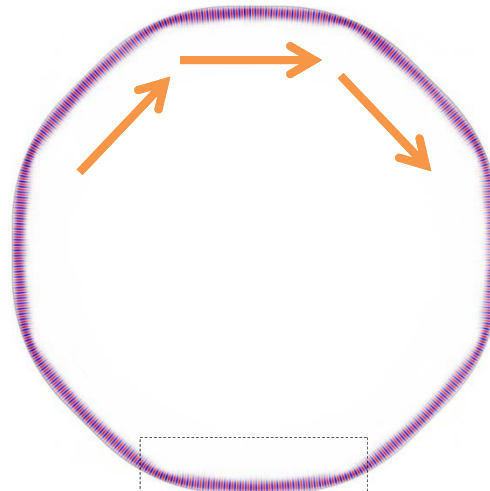
Mode analysis of polygonal silica toroid

Simulation model



Perturbed WG mode

Quasi-WG mode

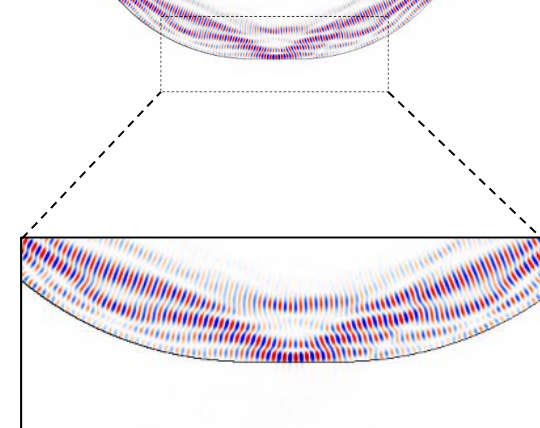
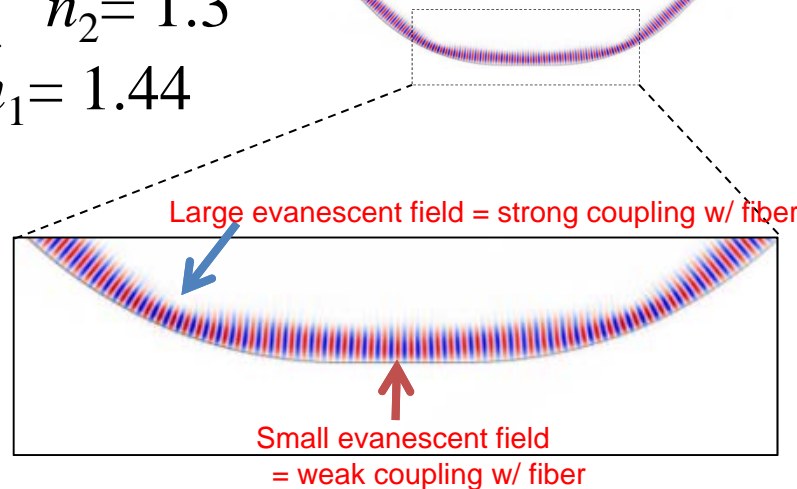


Perturbed WG mode

$$Q = 8.8 \times 10^6$$

Quasi-WG mode

$$Q = 4.5 \times 10^4$$





Coupling coefficient of each part

Polygonal cavity has two ways of coupling

If we use **corner** part

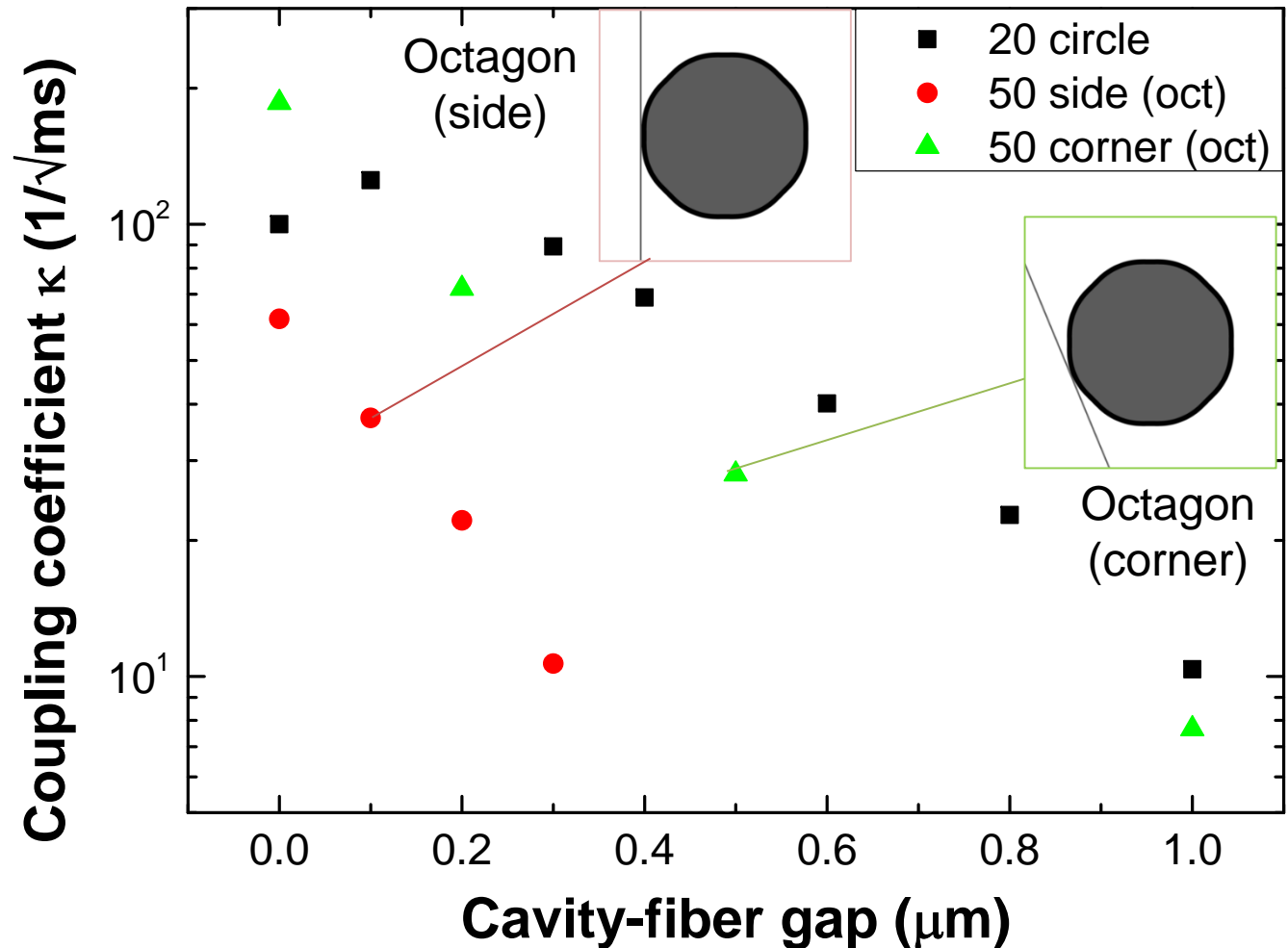


Coupling rate is high

If we use **side** part



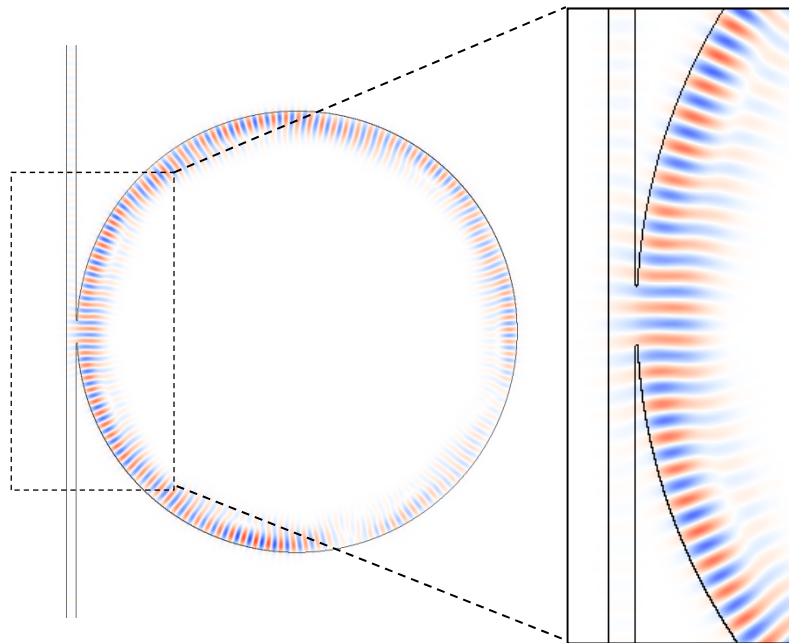
Coupling is suppressed (avoid over-coupling)





Contacting tapered fiber for mechanical stable coupling

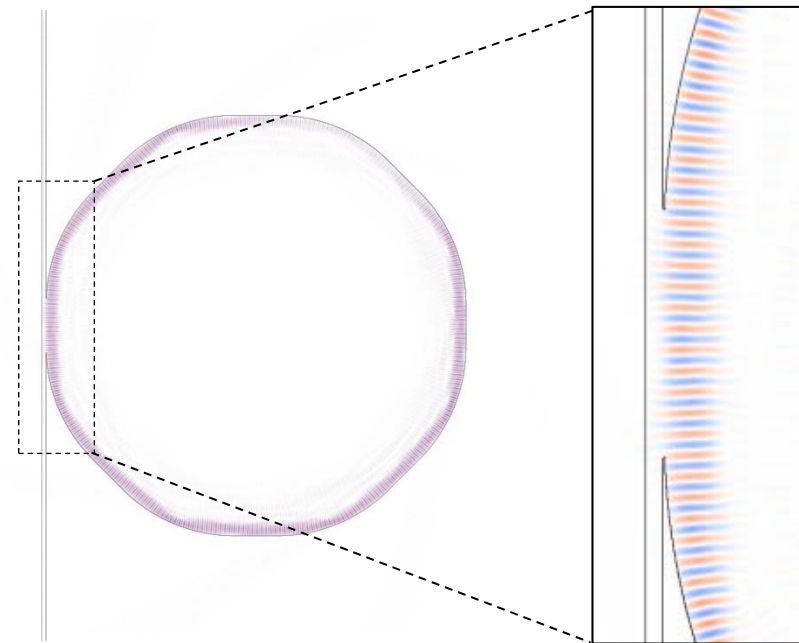
Circular type



Vulnerable to surface condition

$$Q_{\text{load}} = 1.2 \times 10^5$$

Polygonal type



Robust against surface condition

$$Q_{\text{load}} = 3.0 \times 10^5$$



Outline

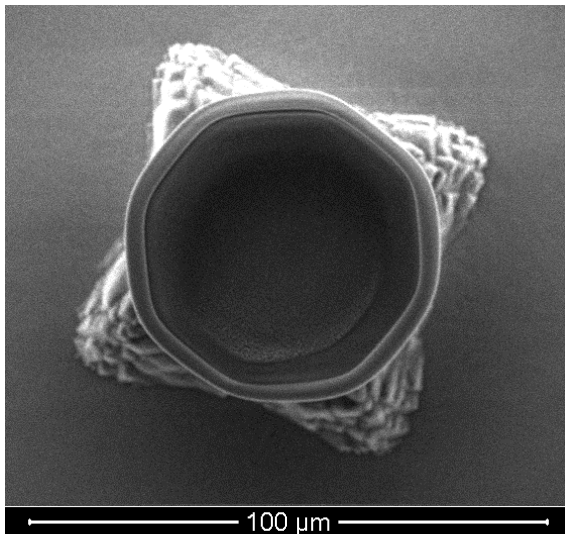
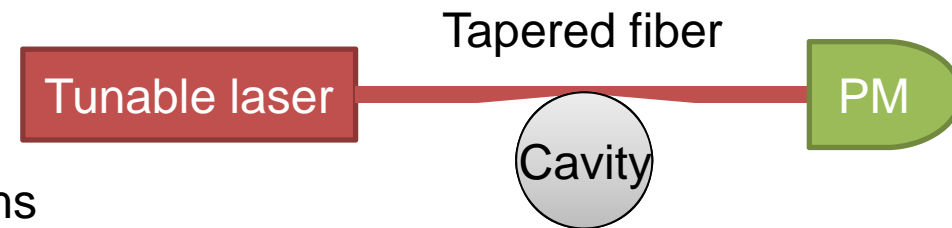
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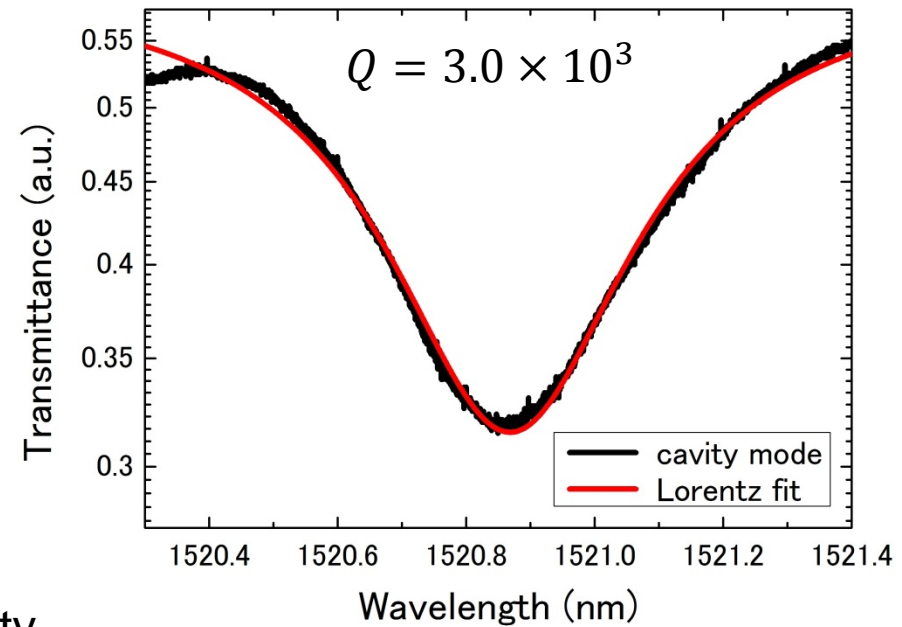
Optical measurement

Device fabrication condition

- ❑ XeF₂ etching 108 seconds
- ❑ KOH etching 1 hour
- ❑ CO₂ laser reflow process 12 W, 100 ms



SEM image of fabricated octagonal cavity





Summary

- We fabricated a polygonal silica toroid using a combination of isotropic and anisotropic etching for sacrificial etching
- We designed a polygonal shape, which enabled to control the coupling by moving the fiber to the corner or side wall
- We suppressed of over-coupling even when we brought the fiber into contact with the surface.
- $Q = 3000$ is demonstrated



Thank you very much

□ Reference

T. Kato, W. Yoshiki, R. Suzuki and T. Tanabe,
“Octagonal silica toroidal microcavity for controlled optical coupling,”
Appl. Phys. Lett. **101**, 121101 (2012)